



PRODUCT DATASHEET

- PLCC6 SMD
- ▶ 3433 1.9t Series
- Red (622nm) / Green
 (527nm) / Blue
 (467nm)





ATTENTION

OBSERVEPRECAUTI FORHANDLING



AEC-Q102



- Package: PLCC6 RGB Top View SMD Package
- Forward Current: 20/20/20mA
- Forward Voltage (typ.): 2.2/3.0/3.0V
- Luminous Flux (typ.): 900/2080/360mcd@20mA
- Colour: Red/Green/Blue
- CCT/Wavelength: 622/527/467nm
- Viewing angle: 120/120/120°
- Materials:
- Resin: Silicon (White Diffused)
- Operating Temperature: -40~+105°C
- Storage Temperature: -40~+105°C
- ESD: 2000V (HBM)
- Grouping parameters:
 - Forward voltage
 - Luminous intensity
 - Dominant Wavelength
- Soldering methods: Reflow soldering
- Preconditioning: MSL 2a according to JEDEC
- **Packing:** 12mm tape with Max.1000pcs/reel, ø180mm (7")

N0M45S25Z



APPLICATIONS:

- Automotive
- LED Display
- Switch Light
- 3C Application
- Decoration Lighting

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CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	lF	50/50/50*	mA
Pulse Forward Current (duty 1/10; width 0.1ms)	Імах	100/100/100	mA
Reverse Voltage	V _R	5	V
Reverse Current @5V	IR	10	μΑ
Electrostatic Discharge (HBM)	ESD	2000	V
Junction Temperature	Tj	110	°C
Thermal Resistance	R _{thJS}	150	°C/W
Soldering Temperature	T _{sol}	260	°C
Operating Temperature	T _{OPR}	-40~+105	°C
Storage Temperature	Tstg	-40~+105	°C

1. * In the order of Red/Green/Blue.

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Values Te						Test
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Red - Forward Voltage	VF	1.8		2.6	V	I⊧=20mA
Red - Luminous Intensity	Iv	640	900	1250	mcd	I⊧=20mA
Red - Wavelength	WP	615		630	nm	I⊧=20mA
Green - Forward Voltage	VF	2.6		3.4	V	I⊧=20mA
Green - Luminous Intensity	lv	1440	2080	2813	mcd	I⊧=20mA
Green - Wavelength	WP	520		535	nm	l⊧=20mA
Blue - Forward Voltage	VF	2.6		3.4	V	I⊧=20mA
Blue - Luminous Intensity	lv	256	360	500	mcd	I⊧=20mA
Blue - Wavelength	WP	460		475	nm	I⊧=20mA
Viewing Angle	2 θ 1/2		120		deg	I⊧=20mA

Electrical & Optical Characteristics (Ta=25°C)

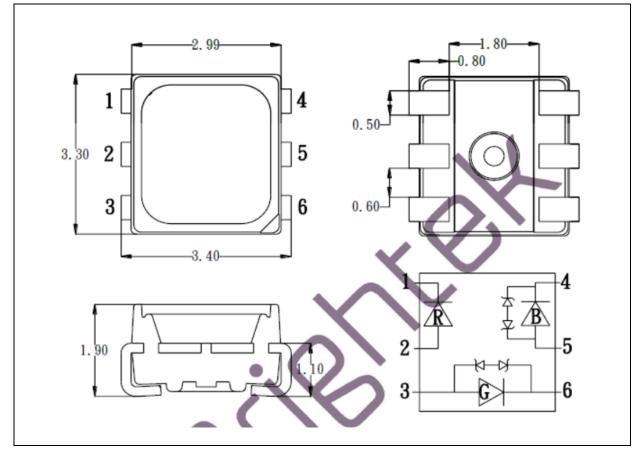
1. Luminous intensity (IV) $\pm 10\%$, Forward Voltage (VF) $\pm 0.1V$, Viewing angle(201/2) $\pm 5\%$, Wavelength (λ) ± 1 nm.

2. We will amend the bin code to maintain bins centralization, and we provide the luminous intensity 1.25double per bin and the dominant wavelength is per 5/5/5nm of the R/G/B per bins.



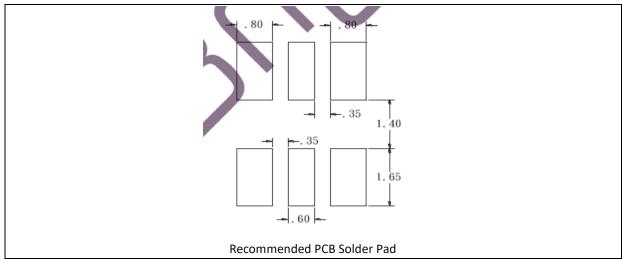
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

Recommended Soldering Pad Dimension:

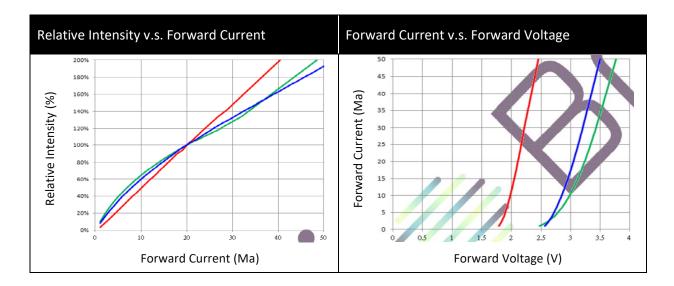


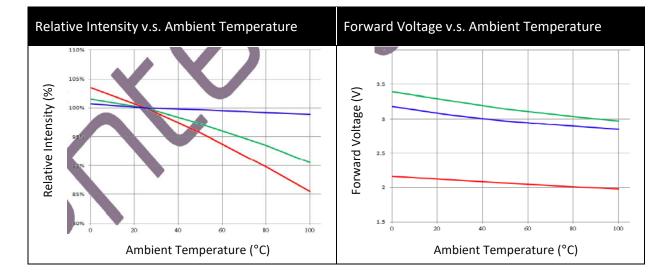
- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance $\pm 0.5^{\circ}$.

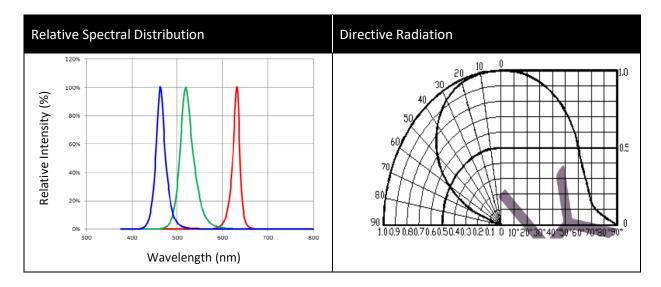
4



ELECTRO-OPTICAL CHARACTERISTICS:

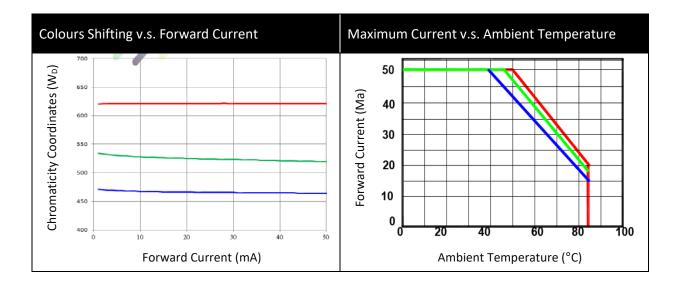








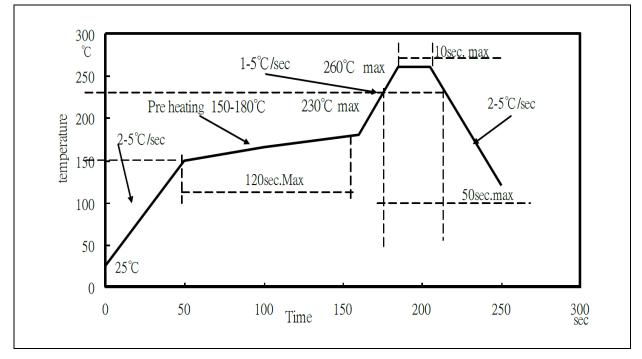
ELECTRO-OPTICAL CHARACTERISTICS:





RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



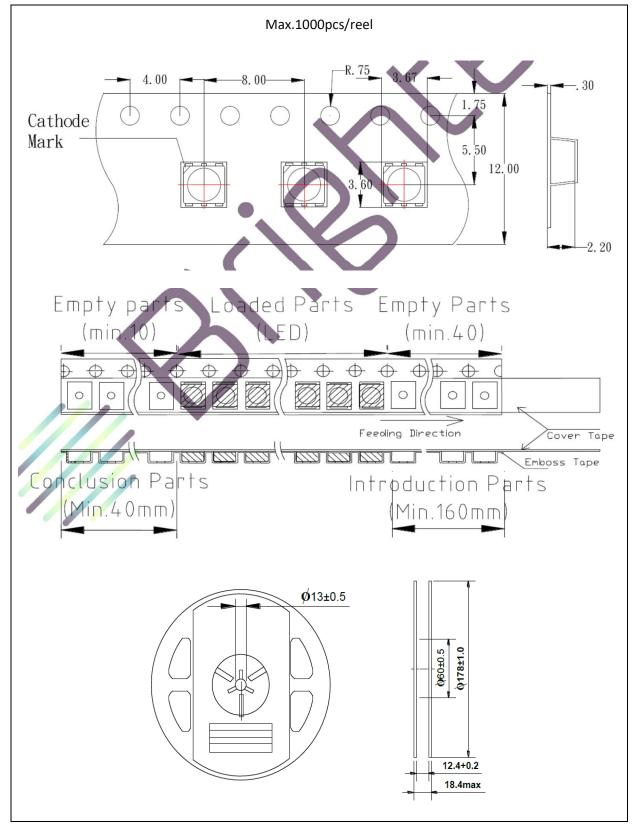
Note:

- 1. Maximum reflow soldering: 1 time.
- 2. Recommended reflow temperature is 240°C; the maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:



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PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

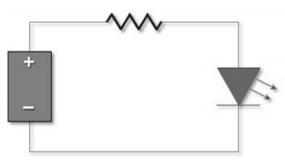
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision		
A1.0	07/04/2018	Datasheet set-up.		
A1.1	04/06/2022	Revise bin ranges.		